APPLICA	BLE	STANI	DARD									
Operating temperature ra			ange	range Opera		· ·		-10 ℃ TO 50 ℃(Packed condition)			on)	
RATING	Voltage					humidit	ting or storage ity range		Re	Relative humidity 90 % MAX (Not o		
Current			1 0.3 A		Applica	able cab	ole		t=0.3±0.03mm, Gold	plating	g	
	ı		<u> </u>	SPEC	IFIC	1OITA	NS					
IT	ГЕМ			TEST METHOD				R	EQU	IREMENTS	QT	AT
CONSTR	RUC	TION					l.					
General examination			Visually a	and by measuring instrumen	t.		Accord	ling to dra	wing	•	×	×
Marking			Confirmed visually.				(note 1)			×	×	
ELECTR	ICAL	_ CHAF	RACTE	RISTICS			l				L	
			90 V AC for 1 min.				No flashover or breakdown.			×	_	
Insulation resistance			100 V DC.				50 MΩ MIN.				×	—
Contact resis	stance	2	AC 20 mV MAX , 1 mA .				100 mΩ MAX.				×	+_
Oomaot rook	CONTACT TESISTATICE			TO TO THE WAY, I THEN.				Including FPC bulk resistance (L=8mm)				
MECHAN	IIC A		DACTE	RISTICS			inciuali	ng FPC b	uik ie	esistance (L=omini)		
Vibration	NICA			ry 10 to 55 Hz, half amplitude	е		① No	electrical	dieco	ontinuity of 1 us	×	Ι_
v ibration			0.75 mm, for 10 cycles in 3 axial directions.				 No electrical discontinuity of 1 μs. Contact resistance: 100 mΩ MAX. 				^	
Shock			981 m/s ² , duration of pulse 6 ms							cand looseness of parts	. ×	_
Machanical aparation		at 3 times in 3 both axial directions. 10 times insertions and extractions.							-	1		
Mechanical operation			10 times insertions and extractions.				 Contact resistance: 100 mΩ MAX. No damage, crack and looseness of parts. 			. ×	_	
FPC insertion force			Measured by applicable FPC				Insertion force : Direction of insertion				×	
			(Thickness of FPC shall be t=0.30mm				2.6+0.14 × n N MAX (<i>note 2</i>)					
FPC retentio	n forc	20	at initial condition.) Measured by applicable FPC				(n: Number of contacts) Retention force : Direction of extraction				-	
rrc reteritio	JII IOIC	,e	(Thickness of FPC shall be t=0.30mm				5+0.07 × n N MIN (<i>note3</i>)			×	-	
			`	condition.)				nber of co	,	,		
ENVIRO	NME	NTAL	CHARA	ACTERISTICS								',
Corrosion sa	alt mis	t		at 35±2 °C, 5 % salt water	spray		① Contact resistance: 100 mΩ MAX.				×	_
Danid shane	. o o f		for 96 h.	55 45 05 05	.45	0500	(C)					
Rapid chang temperature			Temperature-55 \rightarrow +15 _{TO} +35 \rightarrow +85 \rightarrow +15 _{TO} +35 $^{\circ}$ C Time 30 \rightarrow 2 to 3 \rightarrow 30 \rightarrow 2 to 3 min			 Contact resistance: 100 mΩ MAX. Insulation resistance: 50 MΩ MIN. No damage, crack and looseness of parts. 				×		
			Under 5 cycles.									
Damp heat	,		Exposed at 40±2 °C,							×	_	
(steady state	<u> </u>		Relative humidity 90 to 95 %, 96 h. Exposed at -10 to +65 °c,			① C			400 O MAY	+		
Damp heat,c	cyclic		Relative humidity 90 to 96 %,			 Contact resistance: 100 mΩ MAX. Insulation resistance: 1 MΩ MIN. (At high humidity) Insulation resistance: 50 MΩ MIN. (At dry) No damage, crack and looseness of parts 				×	_	
			10 cycles, TOTAL 240 h.									
COUN	IT	DE	SCRIPTIO	ON OF REVISIONS		DESIG	NED			CHECKED	DA	ATE
3			DIS-F-00010250 SE. Y			SE. YOKO	OKOYAMA		HY. YAMAZAKI		+	10713
REMARK						CHECKE		-	D YN. TAKASHITA		70823	
											70823	
				- d			DESIGNE					70823
Unless otherwise specified, refe				er to IEC 60512.		1	DRAWN		/N	HH. MURAKAMI		70823
Note QT:Qualification Test AT:Assurance Test X:Applicable Test				DR	DRAWING NO. ELC-368163-							
HS.		SPECIFICATION SHEET			PART NO.			FH62-**S-0. 25SHW (99				
		HIROS		E ELECTRIC CO., LTD.		CODE NO.		CL580			Δ	1/2

	SPECIFICAT	ONS		
ITEM	TEST METHOD	REQUIREMENTS	QT	АТ
Dry heat	Exposed at 85±2°C, 96 h.	① Contact resistance: 100 mΩ MAX.	×	_
Cold	Exposed at -55±3°C, 96 h.	② No damage, crack and looseness of parts	×	_
Sulphur dioxide [JIS C 60068-2-42]	Exposed at 40 ± 2 °C, Relative humidity $80\pm5\%$ 25 ± 5 ppm for 96 h.	① Contact resistance: 100 m Ω MAX.	×	_
Hydrogen sulphide [JIS C 60068-2-43]	Exposed at 40 ± 2 °C, Relative humidity $80\pm5\%$, 10 to 15 ppm for 96 h.		×	_
Solderability	Soldered at solder temperature, 245±3°C for immersion duration,3±0.3 sec.	A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.	×	-
Resistance to soldering heat	1) Reflow soldering: Peak TMP. 250 °C MAX. Reflow TMP. over 220 °C 60 to 90 sec. Number of reflow: 2 times 2) Soldering irons: TMP. 350±10 °C for 5±1 sec.	No deformation of case of excessive looseness of the terminals. (note 4)	×	

(note 1)

This product features top-contact point.

"One Action Lock" completes FPC lock just by inserting the FPC.

Do not operate the locking-lever when inserting the FPC.

(note 2)

Do not insert the FPC to this product at an angle.

(note 3)

There's a case which FPC retention force doesn't fulfill the value, because FPC specification affects the result of FPC retention force.

Stabilize the FPC to PCB or something fixed, if pull-up or pull-down force is exepected to be applied to the FPC.

(note 4)

Blisters which may be generated on the housing do not affect product performance.

Note QT:Q	ualification Test AT:Assurance Test X:Applicable Test	DRAWIN	NG NO.	ELC-368163-99-00		
HS.	SPECIFICATION SHEET	PART NO.	FH62-**S-0. 25SHW(99)			
	HIROSE ELECTRIC CO., LTD.	CODE NO		CL580	Λ	2/2